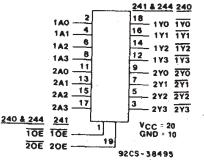
Technical Data _____ CD54/74AC240/241/244 CD54/74ACT240/241/244

Advance Information





Octal Buffer/Line Drivers, 3-State

CD54/74AC/ACT240 - Inverting

CD54/74AC/ACT241 - Non-Inverting CD54/74AC/ACT244 - Non-Inverting

3.6 ns @ $V_{CC} = 5 V$, $T_A = 25^{\circ} C$, $C_L = 50 pF$

Type Features:

Buffered inputs

Typical propagation delay:

FUNCTIONAL DIAGRAM & TERMINAL ASSIGNMENT

The RCA CD54/74AC240, CD54/74AC241, and CD54/74AC244 and the CD54/74ACT240, CD54/74ACT241, and CD54/74ACT244 3-state octal buffer/line drivers use the RCA ADVANCED CMOS technology. The CD54/74AC/ACT240 and CD54/74AC/ACT244 have active-LOW output enables ($\overline{10E}$, $\overline{20E}$). The CD54/74AC/ACT241 has one active-LOW ($\overline{10E}$) and one active-HIGH (20E) output enable.

The CD74AC240 and CD74ACT240 are supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M and M96 suffixes). The CD74AC241 is supplied in 20-lead dual-in-line plastic packages (E suffix) and the CD74ACT241 is supplied in 20-lead dual-in-line plastic packages (E suffix) and 20-lead small-outline packages (M96 suffix). The CD74AC244 and CD74ACT244 are supplied in 20-lead dual-in-line plastic packages (E suffix), 20-lead small-outline packages (M and M96 suffixes), and 20-lead shrink small-outline packages (SM96 suffix). These package types are operable over the following temperature ranges: Commerical (0 to 70° C); Industrial (-40 to +85°C); and Extended Industrial/Military (-55 to + 125°C).

The CD54AC240 and CD54AC244 and the CD54ACT240, CD54ACT241, and CD54ACT244 are supplied in 20-lead hermetic dual-in-line ceramic packages (F3A suffix) and are operable over the -55 to $+125^{\circ}$ C temperature range.

Family Features:

- Exceeds 2-kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latch-up-resistant CMOS process and circuit design
- Speed of bipolar FAST*/AS/S with significantly reduced power consumption
- Balanced propagation delays
- AC types feature 1.5-V to 5.5-V operation and balanced noise immunity at 30% of the supply
 - ± 24-mA output drive current
 - Fanout to 15 FAST* ICs
 - Drives 50-ohm transmission lines

*FAST is a Registered Trademark of Fairchild Semiconductor Corp.

TRUTH TABLES

INPU	OUTPUT	
10E, 20E	10E, 20E A	
L	L	н
L	н	L
н	x	Z

(AC/ACT240)

INP	UTS	OUTPUT	INP	UTS	OUTPUT
10E	1A	1Y	20E	2A	2Y
L	L	L	L	х	Z
L	н	н	н	L	L
н	х	Z	н	н	н

(AC/ACT241)

INPU	OUTPUT	
10E, 20E	0E, 20E A	
L	• L	L
L	Н	н
н	х	Z

(AC/ACT244)

H = HIGH Voltage Level

- L = LOW Voltage Level
- X = Immaterial
- Z = HIGH Impedance

This data sheet is applicable to the CD54/74AC240, CD54ACT240, and CD54/74ACT241. The CD54/74AC241 were not acquired from Harris Semiconductor. See SCHS244 for information on the CD74ACT240, CD74AC244, and CD74ACT244. Copyright © 2004, Texas Instruments Incorporated

Technical, Data

CD54/74AC240/241/244 CD54/74ACT240/241/244

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE (V _{cc})	-0.5 to 6 V
DC INPUT DIODE CURRENT, I_{ik} (for $V_i < -0.5 V$ or $V_i > V_{cc} + 0.5 V$)	+20 mA
DC OUTPUT DIODE CURRENT, I_{OK} (for $V_0 < -0.5$ V or $V_0 > V_{cc} + 0.5$ V)	+50 mA
DC OUTPUT SOURCE OR SINK CURRENT per Output Pin, I _o (for V _o $>$ -0.5 V or V _o $<$ 1	Vcc + 0.5 V) ±50 mA
DC V _{∞} or GROUND CURRENT (I_{cc} or I_{GND})	±100 mA*
POWER DISSIPATION PER PACKAGE (Po):	
For T _A = -40 to +85°C (Package Type E)	
For T _A = -40 to +70°C (Package Type M)	
For T _A = +70 to +85°C (Package Type M)	
$FOI I A = +70 10 +05 C (Fackage Type W) \dots $	Derate Linearly at 6 mW/°C to 310 mW
OPERATING-TEMPERATURE RANGE (T _A): CD54	55 to +125°C
	55 to +125°C
OPERATING-TEMPERATURE RANGE (T _A): CD54 CD74	55 to +125°C 40 to +85°C
OPERATING-TEMPERATURE RANGE (T _A): CD54	55 to +125°C 40 to +85°C
OPERATING-TEMPERATURE RANGE (T _A): CD54 CD74 STORAGE TEMPERATURE (T _{stg})	
OPERATING-TEMPERATURE RANGE (T _A): CD54 CD74 STORAGE TEMPERATURE (T _{stg}) LEAD TEMPERATURE (DURING SOLDERING):	55 to +125°C 40 to +85°C 65 to +150°C +265°C

* For up to 4 outputs per device: add \pm 25 mA for each additional output.

RECOMMENDED OPERATING CONDITIONS:

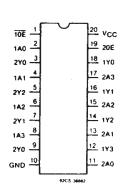
For maximum reliability, normal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIN			
CHARACTERISTIC		MIN.	MAX.	UNITS
Supply-Voltage Range, V _{CC} *:				
(For T _A = Full Package-Temperature Range)				
AC Types		1.5	5.5	v
ACT Types		4.5	5.5	v
DC Input or Output Voltage, VI, Vo		0	VCC	V
Operating Temperature, T _A	CD54	-55	+125	°C
	CD74	-40	+85	C
Input Rise and Fall Slew Rate, dt/dv				
at 1.5 V to 3 V (AC Types)		0	50	ns/V
at 3.6 v to 5.5 V (AC Types)		0	20	ns/V
at 4.5 V to 5.5 V (ACT Types)		0	10	ns/V

* Unless otherwise specified, all voltages are referenced to ground.



VCS 3407 CD54/74AC, ACT240 TYPES TERMINAL ASSIGNMENT



20 VCC TOE 19 20E 2 1A0 240 -3 18 110 17 2A3 4 1A1 16 111 5 2Y2 15 2A2 6 1A2 7 14 1Y2 2¥1 1A3 8 13 2A1 240 -9 12 173 11 2A0 GND 10 92C5-36863

CD54/74AC, ACT241 TYPES TERMINAL ASSIGNMENT

CD54/74AC, ACT244 TYPES TERMINAL ASSIGNMENT

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ار مراجع می مشکوم می این Technical Data CD54/74AC240/241/244 CD54/74ACT240/241/244

STATIC ELECTRICAL CHARACTERISTICS: AC Series

· · · · · · · · · · · · · · · · · · ·						AMBIEN	T TEMPE	RATURE	E (T _A) - ° (C ¹	
CHARACTERISTICS		TEST CONDITIONS		V _{cc} (V)	+	+25		o +85	-55 to +125		UNITS
		V, (V)	l _o (mA)	(V)	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input				1.5	1.2	-	1.2	—	1.2	-	
Voltage	Ун			3	2.1		2.1	—.	2.1		V.
				5.5	3.85	—	3.85		3.85		
Low-Level Input				1.5	_	0.3	_	0.3		0.3	
Voltage	VIL			3		0.9		0.9	<u> </u>	0.9) v
				5.5	_	1.65	-	1.65	-	1.65	
High-Level Output			-0.05	1.5	1.4	_	1.4		1.4	· <u>·</u>	
Voltage	Vон	ViH	-0.05	3	2.9		2.9		2.9	—]
		or	-0.05	4.5	4.4	_	4.4	—	4.4]
		ViL	-4	3	2.58	_	2.48		2.4	<u> </u>	l v
			-24	4.5	3.94	1	3.8	<u> </u>	3.7	·	· ·
	#, * { -75 5.5 3.85	3.85	-		<u> </u>						
		#, <u> </u>	-50	5.5	_		-	_	3.85		1
Low-Level Output		`	0.05	1.5	-	0.1	-	0.1	-	0.1	1
Voltage	VOL	ViH	0.05	3		0.1	_	0.1	—	0.1	
		or	0.05	4.5		0.1		0.1	-	0.1	1
		VIL	12	3	_	0.36	_	0.44	_	0.5] v [
			24	4.5		0.36	-	0.44	_	0.5	1
		#, * {	75	5.5	_		_	1.65	_	·	1
		<i>"</i> ,	50	5.5			_	_	· · ·	1.65	1
Input Leakage Current	h	V _{cc} or GND		5.5	_	±0.1	-	±1	_	±1	μΑ
3-State Leakage Current	loz	VH or VIL									
		V _o = V _{cc} or GND		5.5		±0.5	-	±5		±10	μA
Quiescent Supply Current, MSI	loc	V _{cc} or GND	0	5.5	_	8	_	80	_	160	μΑ

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. *Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

_ Technical Data

CD54/74AC240/241/244 CD54/74ACT240/241/244

STATIC ELECTRICAL CHARACTERISTICS: ACT Series

						AMBIEN	Т ТЕМРЕ	RATURE	E (T _A) - ° (c]
CHARACTERISTICS		TEST CONDITIONS		V _{cc}	+	+25		o +85	-55 to +125		UNITS
		(V)	l _o (mA)	(V)	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
High-Level Input Voltage	ViH			4.5 to 5.5	2		2		2	_	v
Low-Level Input Voltage	VıL			4.5 to 5.5	_	0.8		0.8		0.8	v
High-Level Output		ViH	-0.05	4.5	4.4		4.4	·	4.4		
Voltage	Vон	or ViL	-24	4.5	3.94		3.8	—	3.7	—] v
		#, * {	-75	5.5	—		3.85		—]
			-50	5.5	—	_			· 3.85	—]
Low-Level Output		ViH	0.05	4.5		0.1		0.1	—	0.1]
Voltage	Vol	or ViL	24	4.5	_	0.36	—	0.44		0.5	v
		#, * {	75	5.5	_			1.65]
			50	5.5						1.65	
Input Leakage Current	l,	V _{cc} or GND		5.5		±0.1	_	±1	_	±1	μΑ
3-State Leakage Current	loz	ViH Or ViL									
		Vo = Vcc or		5.5		±0.5	`	±5		±10	μΑ
		GND									
Quiescent Supply Current, MSI	Icc	V _{cc} or GND	0	5.5	_	8		80	—	160	μA
Additional Quiescent S Current per Input Pi TTL Inputs High 1 Unit Load		V _{cc} -2.1		4.5 to 5.5	—	2.4		2.8	_	3	mA

#Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation. * Test verifies a minimum 50-ohm transmission-line-drive capability at +85°C, 75 ohms at +125°C.

CD54/74ACT240					
INPUT UNIT LOADS					
nA0 - A3	1.42				
10E	0.83				
20E	0.83				

ACT INPUT LOADING TABLES CD54/74ACT241

INPUT

nA0 - A3

10Ē

20E

ACT241	CD54/74ACT244			
UNIT LOADS*	INPUT	UNIT LOADS		
0.5	nA0 - A3	0.5		
0.83	10E	0.83		
1.67	20E	0.83		

*Unit load is AI_{cc} limit specified in Static Characteristics Chart, e.g., 2.4 mA max. @ 25°C.

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Technical Data _ CD54/74AC240/241/244 CD54/74ACT240/241/244

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SWITCHING CHARACTERISTICS: AC Series; t,, t, = 3 ns, C_L = 50 pF

			AMBI				
CHARACTERISTICS	SYMBOL	V _{cc} (V)	-40 t	o +85	-55 te		
<u> </u>		(*)	MIN.	MAX.	MIN.	MAX.	1
Propagation Delays: Data to Outputs AC240	tplh tphl	1.5 3.3* 5†	2.6 1.9	82 9.2 6.5	 2.5 1.8	90 10.1 7.2	ns
AC241, 244	tplh tphl	1.5 3.3 5	3 2.2	93 10.5 7.5	 2.9 2.1	103 11.5 8.2	ns
Output Enable Times	tpzi. tpzh	1.5 3.3 5	 4.6 3.1	136 16.4 10.9	 4.5 3	150 18 12	ns
Output Disable Times	tplz tphz	1.5 3.3 5	 3.9 3.1	136 13.6 10.9	— 3.8 3	150 15 12	ns
Power Dissipation Capacitance AC240 AC241, 244	Cpd§			Тур. Тур.	65 Typ. 71 Typ.		pF
Min. (Valley) V _{он} During Switching of Other Outputs (Output Under Test Not Switching)	V _{онv} See Fig. 1	5	4 Typ. @ 25°C			v	
Max. (Peak) V _{OL} During Switching of Other Outputs (Output Under Test Not Switching)	V _{OLP} See Fig. 1	5	1 Тур. @ 25°С		v		
Input Capacitance	Ci			10	-	10	pF
3-State Output Capacitance	Co			15		15	pF

SWITCHING CHARACTERISTICS: ACT Series; t, t, = 3 ns, CL = 50 pF

· · ·			AMBI	Γ _A) - °C			
CHARACTERISTICS	SYMBOL	V _{cc}	-40 to +85		-55 to	UNITS	
		(V)	MIN.	MAX.	MIN.	MAX.	
Propagation Delays: Data to Outputs ACT240	tрін tphi	5†	2.3	7.8	2.2	8.6	ns
ACT241, 244	telh tehl	5	2.5	8.7	2.4	9.6	ns
Output Enable Times	tezi tezi	5	3.5	12.2	3.4	13.4	ns
Output Disable Times	tplz tphz	5	3.5	12.2	3.4	13.4	ns
Power Dissipation Capacitance ACT240 ACT241, 244	Сро§	_		Тур. Тур.	б5 Тур. 71 Тур.		pF
Min. (Valley) V _{он} During Switching of Other Outputs (Output Under Test Not Switching)	V _{онv} See Fig. 1	5	4 Typ. @ 25°C			v	
Max. (Peak) V _{OL} During Switching of Other Outputs (Output Under Test Not Switching)	V _{OLP} See Fig. 1	5	1 Typ. @ 25°C		v		
Input Capacitance	Ci		_	10	-	10	pF
3-State Output Capacitance	Co	_		15	_	15	pF

*3.3 V: min. is @ 3.6 V max. is @ 3 V

†5 V: min. is @ 5.5 V max. is @ 4.5 V C_{PD} is used to determine the dynamic power consumption, per package. For AC series: $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$ For ACT series: $P_D = V_{CC}^2 f_i (C_{PD} + C_L) + V_{CC} \Delta I_{CC}$ where f_i = input frequency

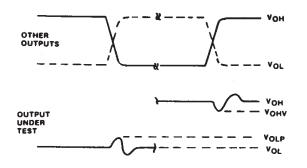
 C_L = output load capacitance

\$¹²,

 $V_{cc} =$ supply voltage.

Technical Data CD54/74AC240/241/244 CD54/74ACT240/241/244

PARAMETER MEASUREMENT INFORMATION



NOTES:

- 1. VOHY AND VOLP ARE MEASURED WITH RESPECT TO A GROUND REFERENCE NEAR THE OUTPUT UNDER TEST. 2. INPUT PULSES HAVE THE FOLLOWING CHARACTERISTICS:
- PRA ≤ 1 MHZ, tr = 3 na, tr = 3 na, SKEW 1 na. 3. R.F. FIXTURE WITH 700-MHZ DESIGN RULES REQUIRED. IC SHOULD BE SOLDERED INTO TEST BOARD AND BYPASSED WITH 0.1 # CAPACITOR. SCOPE AND PROBES REQUIRE 700-MHz BANDWIDTH.

9205-42406

Fig. 1 - Simultaneous switching transient waveforms.

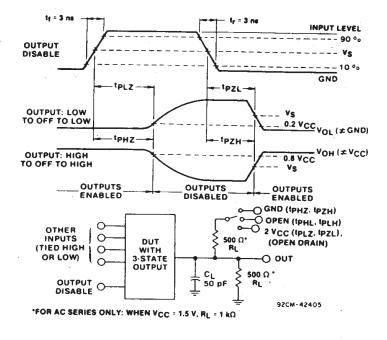
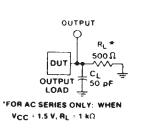
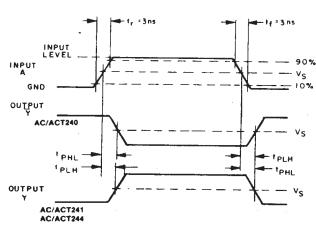


Fig. 2 - Three-state propagation delay times and test circuit.



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9205-42407

Fig. 3 - Propagation delay times and test circuit.

	CD54/74AC	CD54/74ACT
Input Level	V _{cc}	3 V
Input Switching Voltage, Vs	0.5 V _{cc}	1.5 V
Output Switching Voltage, Vs	0.5 V _{cc}	0.5 V _{cc}

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CD54AC240F3A	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54AC240F3A	Samples
CD54AC244F3A	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54AC244F3A	Samples
CD54ACT240F3A	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54ACT240F3A	Samples
CD54ACT241F3A	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54ACT241F3A	Samples
CD54ACT244F3A	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CD54ACT244F3A	Samples
CD74AC240E	ACTIVE	PDIP	Ν	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74AC240E	Samples
CD74AC240EE4	ACTIVE	PDIP	Ν	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74AC240E	Samples
CD74AC240M	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC240M	Samples
CD74AC240M96	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC240M	Samples
CD74AC244E	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74AC244E	Samples
CD74AC244M96	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	AC244M	Samples
CD74ACT240E	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74ACT240E	Samples
CD74ACT240M	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT240M	Samples
CD74ACT240M96	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT240M	Samples
CD74ACT240M96E4	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT240M	Samples
CD74ACT241E	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74ACT241E	Samples
CD74ACT241M96	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT241M	Samples
CD74ACT244E	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD74ACT244E	Samples
CD74ACT244M96	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-55 to 125	ACT244M	Samples



(1) The marketing status values are defined as follows: ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF CD54AC240, CD54AC244, CD54ACT240, CD54ACT241, CD54ACT244, CD74AC240, CD74AC244, CD74ACT240, CD74ACT241, CD74ACT244 :

• Catalog : CD74AC240, CD74AC244, CD74ACT240, CD74ACT241, CD74ACT244

• Military : CD54AC240, CD54AC244, CD54ACT240, CD54ACT241, CD54ACT244

NOTE: Qualified Version Definitions:



- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

*All dimensions are nominal

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



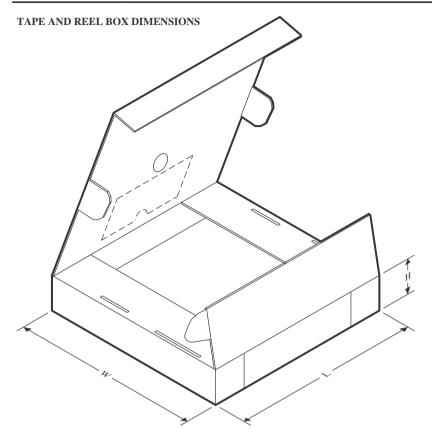
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74AC240M96	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
CD74AC244M96	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
CD74ACT240M96	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
CD74ACT241M96	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
CD74ACT244M96	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1



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PACKAGE MATERIALS INFORMATION

12-May-2023



	*All	dimensions	are	nominal	
--	------	------------	-----	---------	--

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD74AC240M96	SOIC	DW	20	2000	367.0	367.0	45.0
CD74AC244M96	SOIC	DW	20	2000	367.0	367.0	45.0
CD74ACT240M96	SOIC	DW	20	2000	367.0	367.0	45.0
CD74ACT241M96	SOIC	DW	20	2000	367.0	367.0	45.0
CD74ACT244M96	SOIC	DW	20	2000	367.0	367.0	45.0

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
CD74AC240E	N	PDIP	20	20	506	13.97	11230	4.32
CD74AC240EE4	N	PDIP	20	20	506	13.97	11230	4.32
CD74AC240M	DW	SOIC	20	25	507	12.83	5080	6.6
CD74AC244E	N	PDIP	20	20	506	13.97	11230	4.32
CD74ACT240E	N	PDIP	20	20	506	13.97	11230	4.32
CD74ACT240M	DW	SOIC	20	25	507	12.83	5080	6.6
CD74ACT241E	N	PDIP	20	20	506	13.97	11230	4.32
CD74ACT244E	N	PDIP	20	20	506	13.97	11230	4.32

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



DW0020A

EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DW0020A

EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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